

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SIDDHARTHA GOPAL KRISHNA	06/10/2014
VIKRAM VARMA	06/10/2014
<b>RECEIVING PARTY DATA</b>	
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<b>Internal Address:</b>	Law Department
<b>City:</b>	Austin
<b>State/Country:</b>	TEXAS
<b>Postal Code:</b>	78735
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14307472
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	SA25113AC
<b>NAME OF SUBMITTER:</b>	CASSIE YE
<b>SIGNATURE:</b>	/Cassie Ye/
<b>DATE SIGNED:</b>	06/17/2014
<b>Total Attachments: 3</b>	
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## ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **SIDDHARTHA GOPAL KRISHNA AND VIKRAM VARMA; BOTH OF INDIA**, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **METHOD OF TRIMMING CURRENT SOURCE USING ON-CHIP ADC** (Docket No. SA25113AC), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the

inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

GK.  
SIDDHARTHA GOPAL KRISHNA

DATE: 10th June 2014

First Witness

P. Bukadaramana  
SIGNATURE OF WITNESS

DATE: 10th June 2014  
(Month-Day-Year)

P. Bukadaramana  
PRINTED NAME OF WITNESS

G-23, Sector-20, Noida.  
PRINTED ADDRESS OF WITNESS

Second Witness

Ramji Gupta  
SIGNATURE OF WITNESS

DATE: 10th June - 2014  
(Month-Day-Year)

RAMJI GUPTA  
PRINTED NAME OF WITNESS

I-98 GALI NO-5 LAXMI NAGAR DELHI  
PRINTED ADDRESS OF WITNESS

Vikram Varma  
VIKRAM VARMA

DATE: 10 / June / 2014

First Witness

P. Vankataramana  
SIGNATURE OF WITNESS

DATE: 10<sup>th</sup> June 2014  
(Month-Day-Year)

P. Vankataramana  
PRINTED NAME OF WITNESS

A-23, Sector-20, Noida  
PRINTED ADDRESS OF WITNESS

Second Witness

Ramji Gupta  
SIGNATURE OF WITNESS

DATE: 10<sup>th</sup> June 2014  
(Month-Day-Year)

RAMJI GUPTA  
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